

## STV300NH02L

## N-channel 24V - 0.8mΩ - 280A - PowerSO-10 STripFET™ Power MOSFET

PRELIMINARY DATA

### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STV300NH02L	24V	$0.001\Omega$	280A

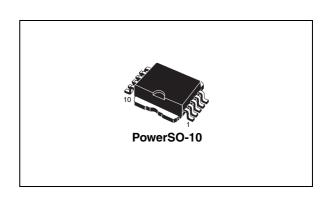
- R<sub>DS(on)</sub>\*Q<sub>g</sub> industry's benchmark
- Conduction losses reduced
- Low profile, very low parasitic inductance
- Switching losses reduced



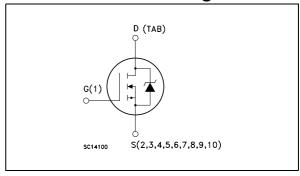
This product utilizes the latest advanced design rules of ST's proprietary STripFET™ technology. This is suitable for high current OR-ing application.

### **Applications**

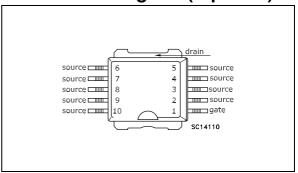
- Switching application
  - OR-ing
  - Specially designed and optimized for high efficiency DC/DC converters.



### Internal schematic diagram



### **Connection diagram (top view)**



#### Order code

Part number	Marking	Package	Packaging	
STV300NH02L	STV300NH02L V300NH02L		Tape & reel	

Electrical ratings STV300NH02L

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (v <sub>gs</sub> = 0)	24	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	280	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100°C	200	А
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	1120	А
P <sub>TOT</sub> (3)	Total dissipation at T <sub>C</sub> = 25°C	300	W
	Derating factor	2	W/°C
E <sub>AS</sub> (4)	Single pulse avalanche energy	2296	mJ
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
T <sub>j</sub>	Operating junction temperature	-55 to 175	

- 1. This value is limited by package
- 2. Pulse with limited by safe operating area
- 3. This value is rated according to Rthj-c
- 4. Starting Tj = 25°C,  $I_D$  = 60A,  $V_{DD}$  = 20V

Table 2. Thermal data

I	Rthj-case	Thermal resistance junction-case max	0.5	°C/W
	Rthj-amb	Thermal resistance junction-ambient max	50	°C/W

## 2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 3. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0	24			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating, $T_c$ =125°C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>DS</sub> = ± 20V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	1.5	2	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 80A		0.8	1	mΩ
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 80A @100°C		1.1		mΩ

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 15V, f = 1 MHz, V <sub>GS</sub> =0		7055 3251 307		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 12V, $I_{D}$ = 120A, $V_{GS}$ = 10V (see Figure 2)		109.4 30.2 26.4		nC nC nC
R <sub>G</sub>	Gate input resistance	$V_{DS} = 0V$ , $f = 1$ MHz, $V_{GS} = 0$		4.4		Ω

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Electrical characteristics STV300NH02L

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD}$ = 12V, $I_{D}$ = 60A $R_{G}$ = 4.7 $\Omega$ $V_{GS}$ = 10V, (see Figure 1)		18 275		ns ns
t <sub>d(off)</sub> t <sub>f</sub>	Turn-off delay time Fall time	$V_{DD}$ = 12V, $I_D$ = 60A $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10V, (see Figure 1)		138 94.4		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)				300 1200	A A
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$I_{SD} = 120A, V_{GS} = 0$			1.3	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 120A,di/dt = 100A/µs $V_{DD}$ = 20V, $T_j$ = 25°C (see Figure 6)		63 85 2.7		ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 120A,di/dt = 100A/µs $V_{DD}$ = 20V, $T_j$ = 150°C (see Figure 6)		63.2 88 2.8		ns nC A

<sup>1.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

STV300NH02L Test circuits

## 3 Test circuits

Figure 1. Switching times test circuit for resistive load

Figure 2. Gate charge test circuit

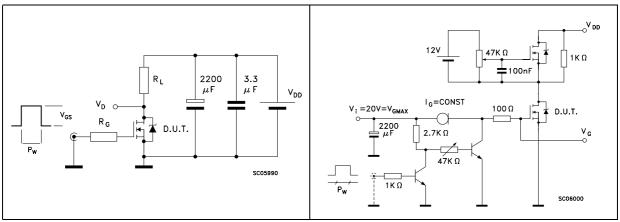


Figure 3. Test circuit for inductive load switching and diode recovery times

Figure 4. Unclamped inductive load test circuit

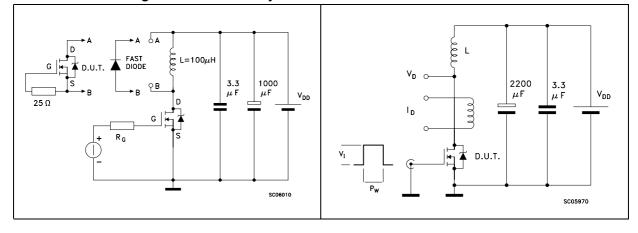
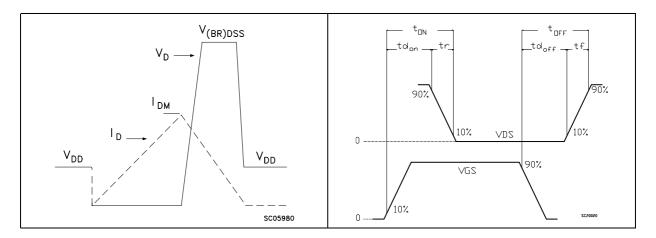


Figure 5. Unclamped inductive waveform

Figure 6. Switching time waveform



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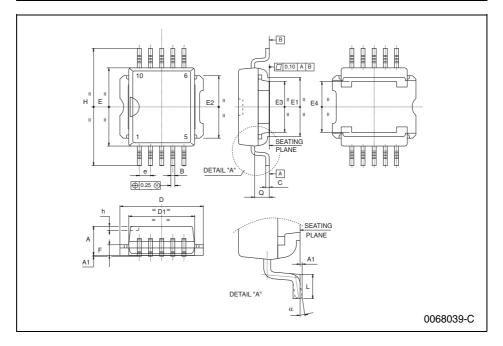
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

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#### **PowerSO-10 MECHANICAL DATA**

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	3.35		3.65	0.132		0.144
A1	0.00		0.10	0.000		0.004
В	0.40		0.60	0.016		0.024
С	0.35		0.55	0.013		0.022
D	9.40		9.60	0.370		0.378
D1	7.40		7.60	0.291		0.300
е		1.27			0.050	
Е	9.30		9.50	0.366		0.374
E1	7.20		7.40	0.283		0.291
E2	7.20		7.60	0.283		0.300
E3	6.10		6.35	0.240		0.250
E4	5.90		6.10	0.232		0.240
F	1.25		1.35	0.049		0.053
h		0.50			0.002	
Н	13.80		14.40	0.543		0.567
L	1.20		1.80	0.047		0.071
q		1.70			0.067	
α	0°		8°			



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Revision history STV300NH02L

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
08-Feb-2007	1	First release

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